



Product Change Notification - JAON-01XOEE717

Date:

01 Jun 2015

Product Category:

Memory; Analog (Linear & Mixed Signal) AND Interface

Notification subject:

CCB 1563 Final Notice: Qualification of palladium coated copper with gold flash (CuPdAu) bond wire in selected products of the 160K wafer technology available in 8L SOIC package at MTAI assembly site.

Notification text:**PCN Status:**

Final notification

Microchip Parts Affected:

See attachments of affected catalog part numbers (CPN) labeled as...

[PCN_JAON-01XOEE717_Affected_CPN.xls](#)

[PCN_JAON-01XOEE717_Affected_CPN.pdf](#)

Description of Change:

Qualification of palladium coated copper with gold flash (CuPdAu) bond wire in selected products of the 160K wafer technology available in 8L SOIC package at MTAI assembly site.

NOTE: Selected products are non-automotive devices. Please review the affected CPN lists (attached) to identify the actual parts affected.

Pre Change:

Gold (Au) bond wire

Post Change:

Palladium coated copper with gold flash (CuPdAu) bond wire

Impacts to Data Sheet:

None

Reason for Change:

To improve manufacturability and qualify CuPdAu bond wire at MTAI assembly site.

Change Implementation Status:

In Progress

Estimated First Ship Date:

June 26, 2015 (date code: 1526)

NOTE: Please be advised that after the estimated first ship date customers may receive pre and post change parts.

Markings to Distinguish Revised from Unrevised Devices:

Traceability code

Revision History:

April 08, 2015: Issued initial notification.

June 01, 2015: Issued final notification. Attached the qualification report.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s):

[PCN_JAON-01XOEE717_Qual_Report.pdf](#)

[PCN_JAON-01XOEE717_Affected_CPN.pdf](#)

[PCN_JAON-01XOEE717_Affected_CPN.xls](#)

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